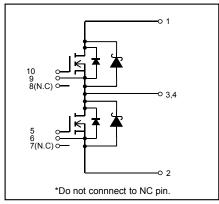
#### Application

- · Motor drive
- · Inverter, Converter
- · Photovoltaics, wind power generation.
- · Induction heating equipment.

#### Features

- 1) Low surge, low switching loss.
- 2) High-speed switching possible.
- 3) Reduced temperature dependence.

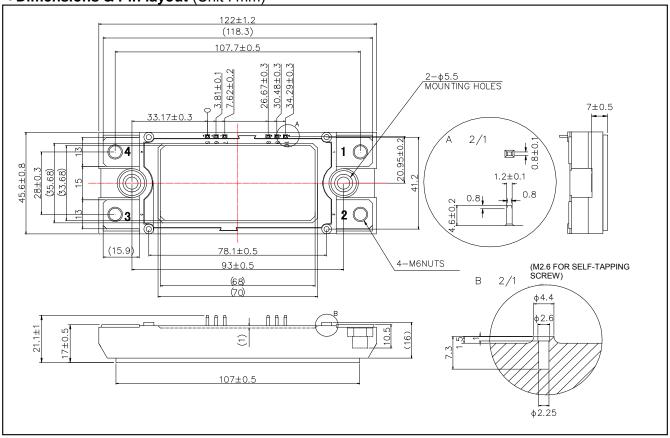
# ●Circuit diagram



#### Construction

This product is a half bridge module consisting of SiC-DMOS and SiC SBD from ROHM.

●Dimensions & Pin layout (Unit : mm)

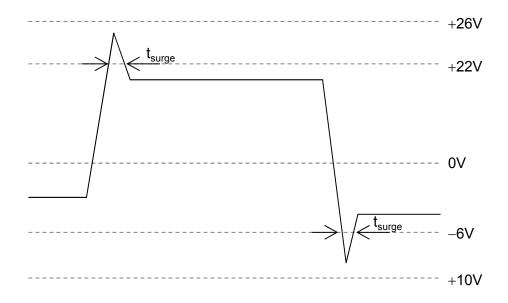


## ● Absolute maximum ratings (Tj = 25°C)

Parameter	Symbol	Conditions	Limit	Unit	
Drain-source voltage	$V_{DSS}$	G-S short	1200		
Gate-source voltage(+)	V	D-S short	22	V	
Gate-source voltage(-)	$V_{GSS}$	D-3 \$1101t	<b>–6</b>	<b>V</b>	
G - S voltage (t <sub>surge</sub> <300nsec)	$V_{GSSsurge}$	D-S short	-10 to 26		
Drain current *1	I <sub>D</sub>	DC(T <sub>c</sub> =60°C)	80		
	I <sub>DRM</sub>	Pulse (T <sub>c</sub> =60°C) 1ms *2	160		
Source current *1	I <sub>S</sub>	$DC(T_c = 60^{\circ}C) V_{GS} = 18V$	80	Α	
	I <sub>SRM</sub>	Pulse (T <sub>c</sub> =60°C) 1ms V <sub>GS</sub> =18V	160		
Total power disspation *3	Ptot	T <sub>c</sub> =25°C	600	W	
Max junction temperature	T <sub>jmax</sub>		175		
Junction temperature	$T_jop$		-40 to150	°C	
Storage temperature	T <sub>stg</sub>		-40 to125		
Isolation voltage	Visol	Terminals to baseplate, f=60Hz AC 1min.	2500	Vrms	
Mounting torque		Main Terminals : M6 screw	4.5	N · m	
	_	Mounting to heat shink : M5 screw	3.5	ווייוו	

<sup>(\*1)</sup> Case temperature (T<sub>c</sub>) is defined on the surface of base plate just under the chips.

#### Example of acceptable Vgs waveform



<sup>(\*2)</sup> Repetition rate should be kept within the range where temperature rise if die should not exceed T<sub>jmax</sub>.

<sup>(\*3)</sup> T<sub>i</sub> is less than 175°C

## ●Electrical characteristics (Tj=25°C)

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Unit
On-state static Drain-Source Voltage	V <sub>DS(on)</sub>	I <sub>D</sub> =80A, V <sub>GS</sub> =18V	T <sub>j</sub> =25°C	_	2.8	3.5	
			T <sub>j</sub> =125°C	_	4.2	_	V
			T <sub>j</sub> =150°C	1	4.8	5.5	
Drain cutoff current	I <sub>DSS</sub>	V <sub>DS</sub> =1200V, V <sub>GS</sub> =0V		-	1	1.2	mA
Source-drain voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =80A	T <sub>j</sub> =25°C		1.7	2.0	V
			T <sub>j</sub> =125°C	1	2.1	_	
			T <sub>j</sub> =150°C	-	2.3	3.3	
		V <sub>GS</sub> =18V, I <sub>S</sub> =80A	T <sub>j</sub> =25°C	-	1.4	_	
			T <sub>j</sub> =125°C	_	1.7	_	
			T <sub>j</sub> =150°C	-	1.8	_	
Gate-source threshold voltage	$V_{GS(th)}$	V <sub>DS</sub> =10V, I <sub>D</sub> =13.2mA		1.6	_	4	V
Gate-source leak current	I <sub>GSS</sub>	V <sub>GS</sub> =22V, V <sub>DS</sub> =0V			_	0.5	μΑ
	GSS	$V_{GS}$ = -6V, $V_{DS}$ =0V		-0.5	_	_	μΛ
Switching characteristics	t <sub>d(on)</sub>	$V_{GS(on)}$ =18V, $V_{GS(off)}$ =0V			20		ns
	t <sub>r</sub>	V <sub>DS</sub> =600V			30	_	
	t <sub>rr</sub>	I <sub>D</sub> =80A			35		
	$t_{d(off)}$	$R_G=0.82\Omega$			80	_	
	$t_f$	inductive load		_	40	_	
Input capacitance	Ciss	V <sub>DS</sub> =10V, V <sub>GS</sub> =0V, f=1MHz		_	8	_	nF
Gate Registance	$R_{Gint}$	T <sub>j</sub> =25°C			3.0	_	Ω
Stray Inductance	Ls				25	_	nH
Creepage distance	-	Terminal to heat sink			11.5	_	mm
		Terminal to terminal			19.0	_	mm
Clearance distance	-	Terminal to heat sink			9.5	_	mm
		Terminal to terminal			13.0	_	mm
Junction-to-case thermal	R <sub>th</sub> (j-c)	DMOSFET (1/2 module) *5		-	_	0.25	°C/W
resistance	i (thu o)	SBD (1/2 module) *5		ı	_	0.32	
Case-to-heat sink	R <sub>th</sub> (c-f)	Case to heat sink, per 1 module, Thermal grease appied * <sup>6</sup>		-	0.035	_	
Thermal resistance	T Nth(C-1)						

- (\*4) In order to prevent self turn-on, it is recommended to apply negative gate bias.
- (\*5) Measurement of Tc is to be done at the point just under the chip.
- (\*6) Typical value is measured by using thermally conductive grease of λ=0.9W/(m K).
- (\*7) SiC devices have lower short cuicuit withstand capability due to high current density. Please be advised to pay careful attention to short cuicuit accident and try to adjust protection time to shutdown them as short as possible.
- (\*8) If the Product is used beyond absolute maximum ratings defined in the Specifications, as its internal structure may be dameged, please replace such Product with a new one.

<Wavelength for Switching Test>

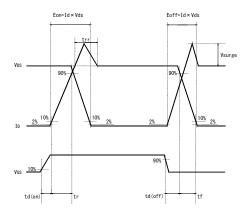


Fig.1 Typical Output Characteristics [T<sub>j</sub>=25°C] V<sub>GS</sub>=16V V<sub>GS</sub>=18V 120 Drain Current: I<sub>D</sub> [A] V<sub>GS</sub>=20V V<sub>GS</sub>=14V 80 V<sub>GS</sub>=12V 40 V<sub>GS</sub>=10V 0 0 2 6 Drain-Source Voltage: V<sub>DS</sub> [V]

8  $V_{GS}=18V$ 7 Drain-Source Voltage: V<sub>DS</sub> [V] 6 T<sub>j</sub>=125°C 5 T<sub>i</sub>=150°C 4 T<sub>i</sub>=25°C 3 2 1 0 40 80 120 160

Drain Current : I<sub>D</sub> [A]

Fig.2 Drain-Source Voltage vs. Drain Current

Fig.3 Drain-Source Voltage vs. Gate-Source Voltage [T<sub>i</sub>=25°C] 8 T<sub>i</sub>=25°C 7 Drain-Source Voltage: V<sub>DS</sub> [V] 6 5 4 3 I<sub>D</sub>=80A 2 I<sub>D</sub>=60A I<sub>D</sub>=40A 1 I<sub>D</sub>=20A 0 12 14 16 18 20 22 24 Gate-Source Voltage : V<sub>GS</sub> [V]

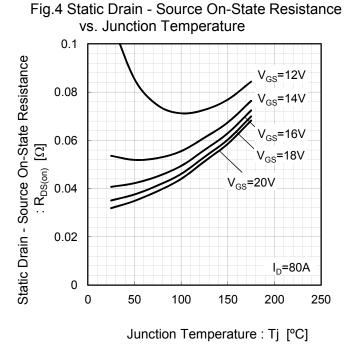


Fig.5 Forward characteristic of Diode

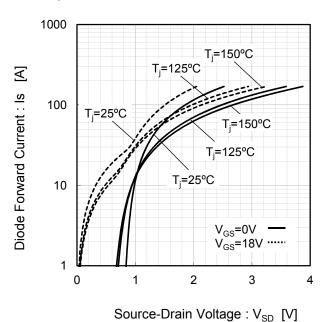
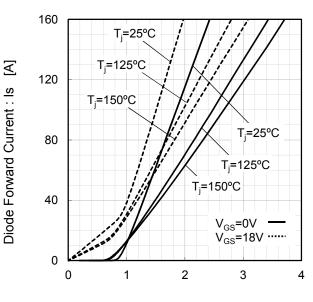


Fig.6 Forward characteristic of Diode



Source-Drain Voltage: V<sub>SD</sub> [V]

Fig.7 Drain Current vs. Gate-Source Voltage

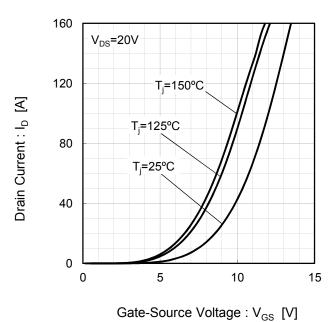
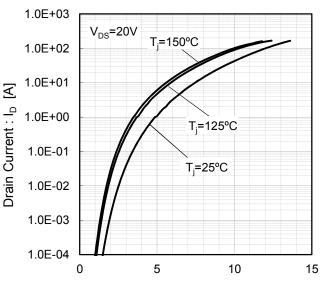


Fig.8 Drain Current vs. Gate-Source Voltage



Gate-Source Voltage: V<sub>GS</sub> [V]

Fig.9 Switching Characteristics [T<sub>i</sub>=25°C]

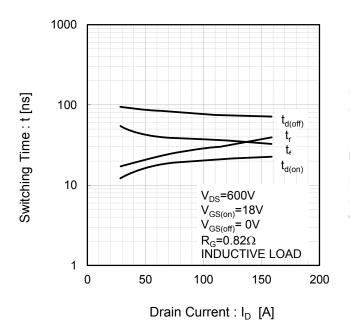


Fig.10 Switching Characteristics [T<sub>i</sub>=125°C]

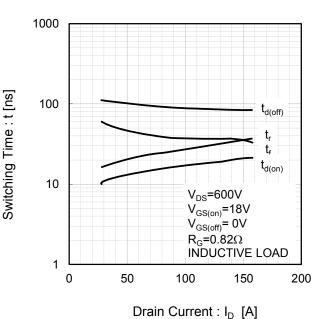


Fig.11 Switching Characteristics [T<sub>i</sub>=150°C]

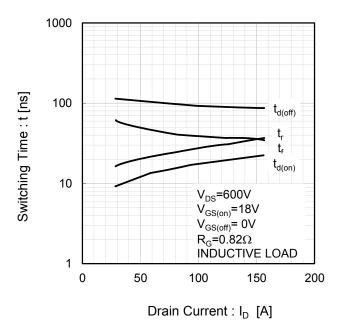
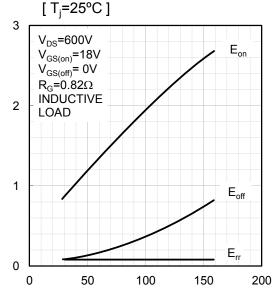


Fig.12 Switching Loss vs. Drain Current



Switching Loss [mJ]

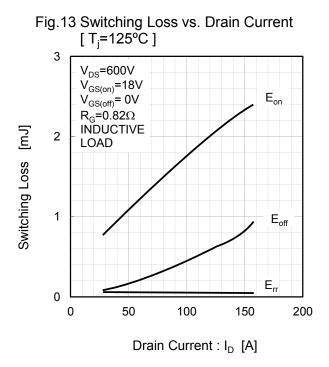
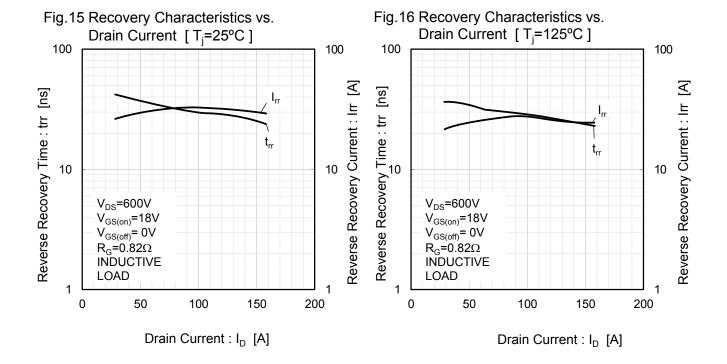
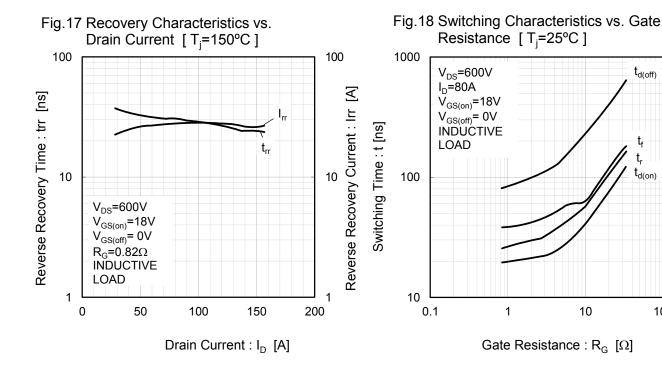


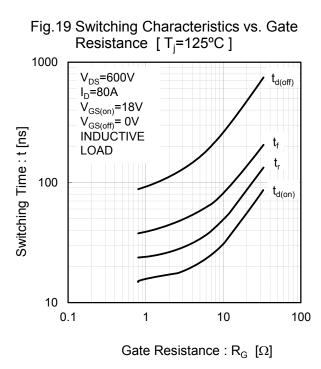
Fig.14 Switching Loss vs. Drain Current [T<sub>i</sub>=150°C] 3 V<sub>DS</sub>=600V V<sub>GS(on)</sub>=18V  $E_{on}$  $V_{GS(off)} = 0V$  $R_G = 0.82\Omega$ INDUCTIVE [m] 2 LOAD Switching Loss  $\mathsf{E}_{\mathsf{off}}$ 1  $\mathsf{E}_{\mathsf{rr}}$ 0 50 100 200 0 150 Drain Current : I<sub>D</sub> [A]

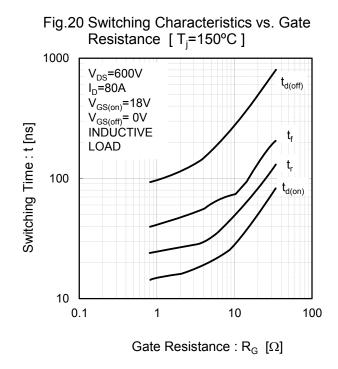


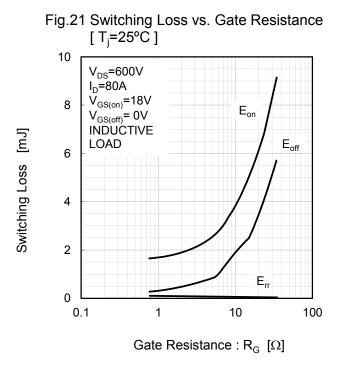
100

#### ●Electrical characteristic curves (Typical)









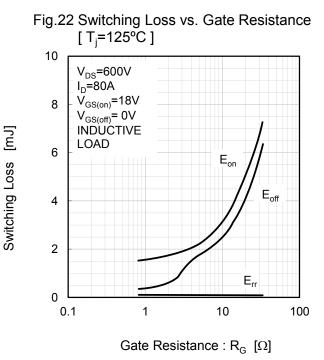


Fig.23 Switching Loss vs. Gate Resistance [T<sub>i</sub>=150°C] 10 V<sub>DS</sub>=600V I<sub>D</sub>=80A  $V_{GS(on)}$ =18V  $V_{GS(off)}$ = 0V INDUCTIVE 8 LOAD 6  $\mathsf{E}_{\mathsf{off}}$ 4 2  $E_{rr}$ 0 0.1 1 10 100 Gate Resistance :  $R_G$  [ $\Omega$ ]

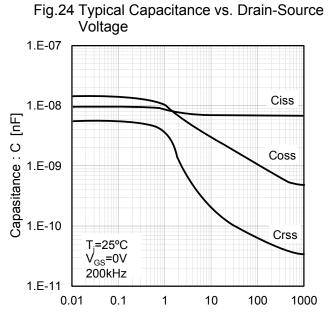
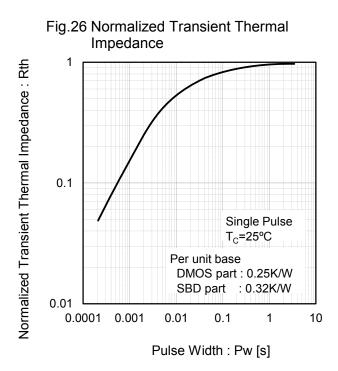


Fig.25 Gate Charge Characteristics [T<sub>i</sub>=25°C] 25 Gate-Source Voltage: V<sub>GS</sub> [V] 20 15 10 5 I<sub>D</sub>=80A T<sub>i</sub>=25°C √<sub>DS</sub>=600V 0 100 200 300 400 500 0

Drain-Source Voltage : V<sub>DS</sub> [V]

Total Gate charge : Qg [nC]



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Part Number	BSM080D12P2C008
Package	С
Unit Quantity	12
Minimum Package Quantity	12
Packing Type	Tray
Constitution Materials List	inquiry
RoHS	Yes